

SEMICS OPUS 3

- Manufacturer: SEMICS
- Model: OPUS 3
- Serial: S13A9C07
- Vintage: Dec 2013
- Tri Temp: Ambient to 200°C, Pre-cold option
- Software Revision: V3.0.4863
- OCR
- Wide Area polish Plate,
- Multi area Polish software (up to 3 area)
- Chuck Blow
- GPIB With Cables
- Handy bar code reader
- Bridge low/high magnification
- Probe Card / Lot Reader Management (RFID)
- 12" Single Foup/FOSB/Open cassette
- 6" / 8" / 12" Wafer Size
- Network license – SECSGEM – ST Inkless Automation Program
- Color main camera
- Pin To Pad Alignment & Optimization
- PMI (Probe Mark Ins.)
- Real Time Wafer Map, Control Map
- Wafer Map Converter (STIFF, E142, ...)
- Multi Die Test up to 256
- Noise Shielding
- 480 mm Probe Card Clamping System
- Probe card changer 480mm (incl. 1 change kit)
- 480 mm Probe Card Clamping System
- Combo480 Kit
- Combo Head plate
- Combo Insert ring (tester dependant)
- Motorized Needle clean up to 80Kg
- Remote control License Fee per Prober (VNC)
- Mini keyboard
- Voltage: 200~240VAC; 50/ 60Hz